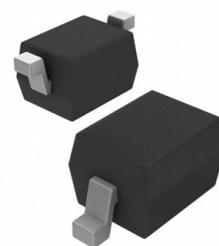


Features

- * Ultra low leakage: nA level
- * Low clamping voltage
- * RoHS Compliant
- * REACH & SVHC Compliant
- * Halogen Compliant
- * SOD-323 Package

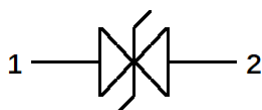


Marking Diagram



Top view

Circuit Diagram

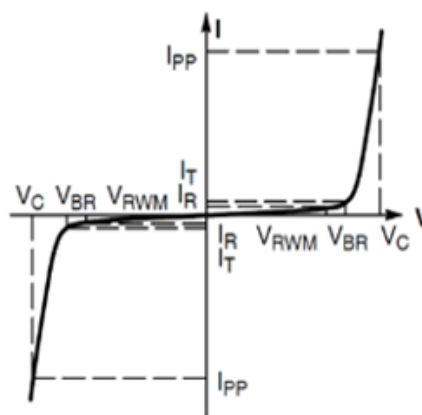


Ordering Information

Part Number	Packaging	Reel Size
PESD5V0S1BA,115-CN	3000/Tape & Reel	7 inch

Portion Electronics Parameter

Symbol	Parameter
V_{RWM}	Peak Reverse Working Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_R
I_T	Test Current
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}

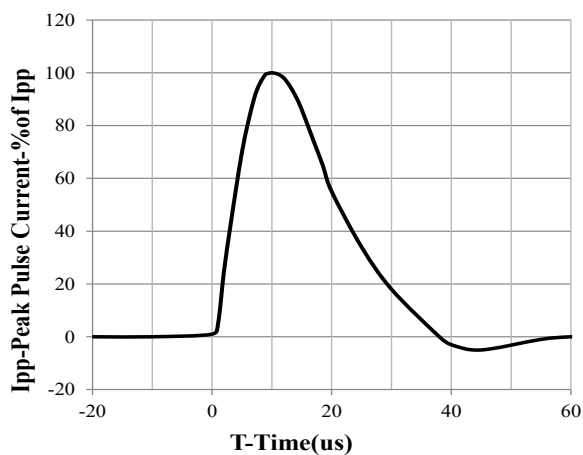
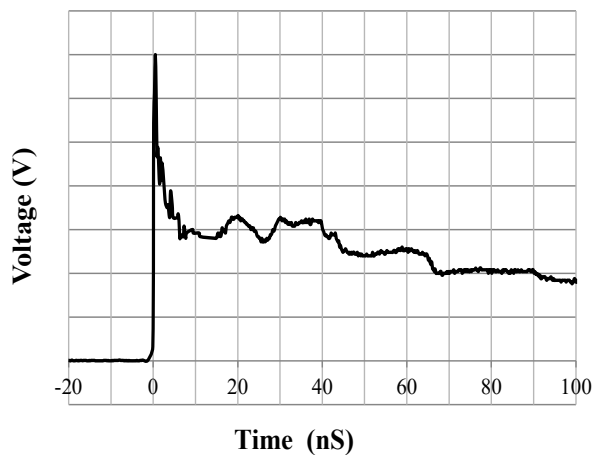
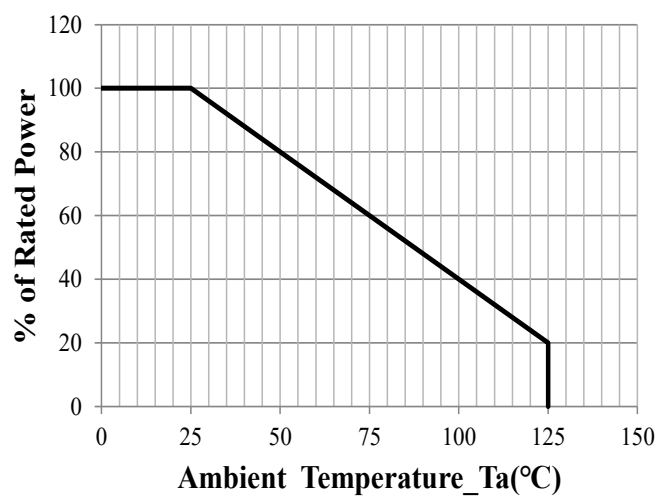


Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

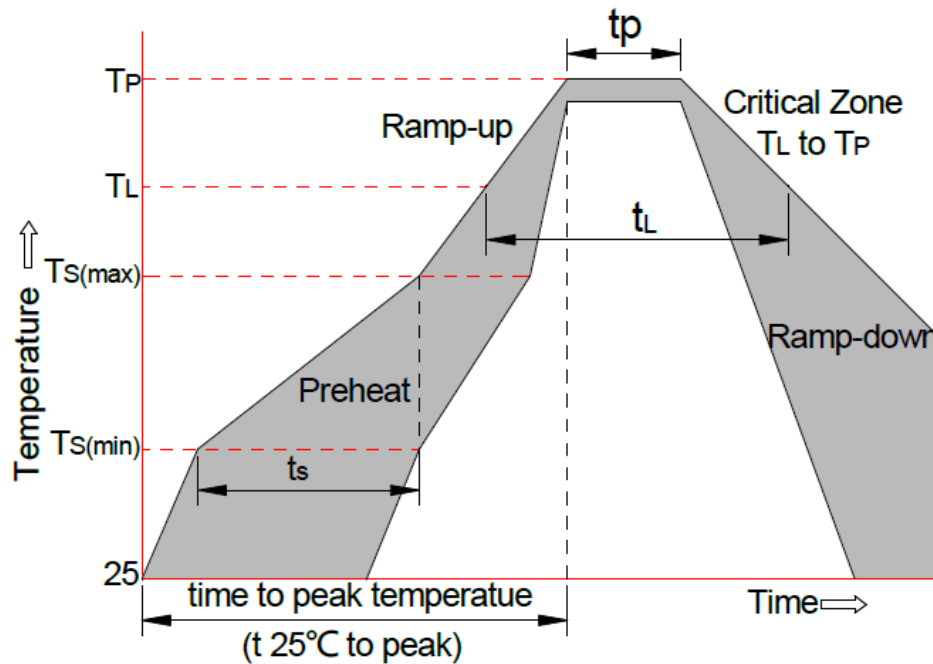
Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 μs pulse)	P_{pk}	120	W
Peak Pulse Current (8/20 μs pulse)	I_{PP}	10	A
ESD per IEC 61000-4-2 (Air)	V_{ESD}	± 30	kV
ESD per IEC 61000-4-2 (Contact)		± 30	
Operating Temperature Range	T_J	-55 to +125	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^{\circ}\text{C}$

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				5	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	6	7.1	8.5	V
Reverse Leakage Current	I_R	$V_{RWM} = 5\text{V}$		<10	100	nA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$ (8 / 20 μs pulse)		7.1	9	V
Clamping Voltage	V_C	$I_{PP} = 10\text{A}$ (8 / 20 μs pulse)		8.3	12	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$,		17	25	pF

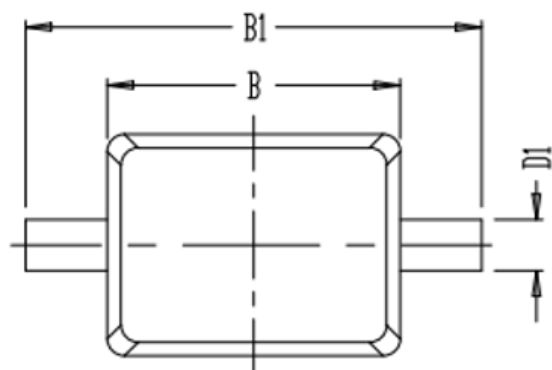
Typical Performance Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise Specified)

8 / 20us Pulse Waveform

IEC61000-4-2 Pulse Waveform

Power Derating Curve

Soldering Parameters

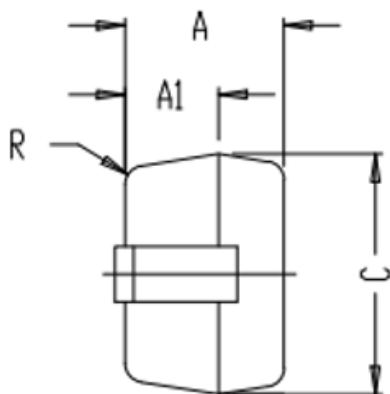


Reflow Condition		Pb-Free Assembly
Pre-heat	-Temperature Min ($T_{S(min)}$)	+150°C
	-Temperature Max ($T_{S(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs
Average ramp up rate(Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{S(max)}$ to T_L -Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature (T_L) (Liquid us)	+217°C
	-Temperature (t_L)	60-150 secs
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6 °C/secs. Max
xTime 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

SOD-323 Package Outline Drawing

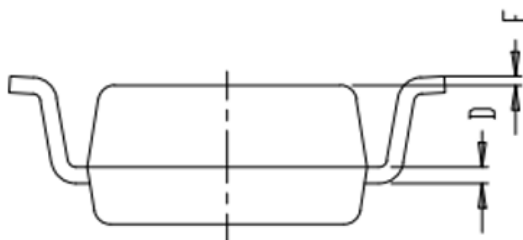


TOP VIEW



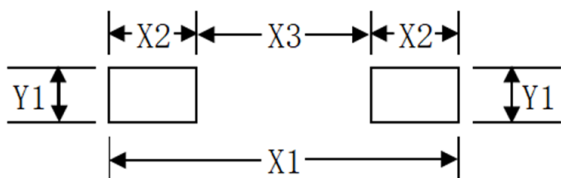
SIDE VIEW

SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	Min	Typ	Max	Min	Typ	Max
A	0.70	0.80	0.90	0.0276	0.0315	0.0354
A1	0.45	0.50	0.55	0.0177	0.0197	0.0217
B	1.65	1.70	1.75	0.0650	0.0669	0.0689
B1	2.55	2.65	2.75	0.1004	0.1043	0.1083
C	1.25	1.30	1.35	0.0492	0.0512	0.0531
D	0.10	0.11	0.12	0.0039	0.0043	0.0047
D1	0.28	0.30	0.32	0.0110	0.0118	0.0126
E	—	—	0.10	—	—	0.0039
R	0.02	—	0.05	0.0008	—	0.0020



SIDE VIEW

Suggested Land Pattern



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
X1	3.20	0.126
X2	0.80	0.031
X3	1.60	0.063
Y1	0.50	0.020

NOTICE

The information presented in this document is for reference only. Involving product optimization and productivity improvement, ChipNobo reserves the right to adjust product indicators and upgrade some technical parameters. ChipNobo is entitled to be exempted from liability for any delay or non-delivery of the information disclosure process that occurs.

本文件中提供的信息仅供参考。涉及产品优化和生产效率改善，ChipNobo 有权调整产品指标和部分技术参数的升级，所出现信息披露过程存在延后或者不能送达的情形，ChipNobo 有获免责权。

The product listed herein is designed to be used with residential and commercial equipment, and do not support sensitive items and specialized equipment in areas where sanctions do exist. ChipNobo Co., Ltd or anyone on its behalf, assumes no responsibility or liability for any damages resulting from improper use.

此处列出的产品旨在民用和商业设备上使用，不支持确有制裁地区的敏感项目和特殊设备，ChipNobo 有限公司或其代表，对因不当使用而造成的任何损害不承担任何责任。

For additional information, please visit our website <http://www.chipnobo.com>, or consult your nearest Chipnobo sales office for further assistance.

欲了解更多信息，请访问我们的网站 <http://www.chipnobo.com>，或咨询离您最近的 Chipnobo 销售办事处以获得进一步帮助。